

Sir:

Transmitted herewith for filing is the Patent Application of:

Inventor: PING-YI HSIN, ZIN CHEIN WEI

For: METHOD OF FORMING METAL-INSULATOR-METAL (MIM) CAPACITORS AT COPPER PROCESS

Enclosed are:

6 sheets of drawing(s) - formal.

An assignment of the invention to **Taiwan Semiconductor Manufacturing Co.**

An associate power of attorney Applicant claims small entity status

Request & Certification under 35 USC 122(b)(2)(b)(i)

The filing fee has been calculated as shown below:

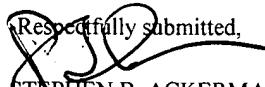
	(Col. 1)	(Col. 2)	OTHER THAN A SMALL ENTITY	
FOR:	NO. FILED	NO. EXTRA	RATE	FEE
BASIC FEE				\$ 770.
TOTAL CLAIMS	30 -20=	10	x 18 =	\$ 180.
INDEP CLAIMS	3 -3=	0	x 86 =	\$ 0.
			SUB TOTAL	\$ 950.
			ASSIGNMENT	\$40.
			TOTAL	\$ 990.

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Any additional filing fees required under 37 CFR §1.16.

Any patent application processing fees under 37 CFR §1.17.

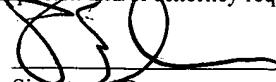
Respectfully submitted,

STEPHEN B. ACKERMAN, REG. NO. 37,761

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I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail in an envelope addressed to Assistant Commissioner of Patents, Alexandria, VA, 22313-1450. Applicant and/or Attorney requests the date of deposit as the Filing Date.

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